Preferred Device

Silicon Tuning Diode

These devices are designed in the popular Plastic Surface Mount Package for high volume requirements of FM Radio and TV tuning and AFC, general frequency control and tuning applications. They provide solid–state reliability in replacement of mechanical tuning methods.

- High Q
- Controlled and Uniform Tuning Ratio
- Standard Capacitance Tolerance 10%
- Complete Typical Design Curves
- Device Marking: 4G



ON Semiconductor™

http://onsemi.com

30 VOLTS VOLTAGE VARIABLE CAPACITANCE DIODE

MAXIMUM RATINGS

Symbol	Rating	Value	Unit
٧R	Continuous Reverse Voltage	30	Vdc
ΙF	Peak Forward Current	200	mAdc

THERMAL CHARACTERISTICS

Symbol	Characteristic	Max	Unit
PD	Total Device Dissipation FR–5 Board,* TA = 25°C Derate above 25°C	200 1.57	mW mW/°C
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	635	°C/W
T _J , T _{stg}	Junction and Storage Temperature	150	°C

^{*}FR-4 Minimum Pad



PLASTIC SOD-323 CASE 477



ORDERING INFORMATION

Device	Package	Shipping		
MMVL2101T1	SOD-323	3000 / Tape & Reel		

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I _R = 10 μAdc)	V _{(BR)R}	30	_	_	Vdc
Reverse Voltage Leakage Current (V _R = 25 Vdc, T _A = 25°C)	lR	_	_	0.1	μAdc
Diode Capacitance Temperature Coefficient (V _R = 4.0 Vdc, f = 1.0 MHz)	TCC	_	280	_	ppm/°C

	C _T , Diode Capacitance V _R = 4.0 Vdc, f = 1.0 MHz pF		Q, Figure of Merit V _R = 4.0 Vdc, f = 50 MHz	TR, Tuning Ratio C ₂ /C ₃₀ f = 1.0 MHz		io	
Device	Min	Nom	Max	Тур	Min	Тур	Max
MMVL2101T1	6.1	6.8	7.5	450	2.5	2.7	3.2

PARAMETER TEST METHODS

1. C_T, DIODE CAPACITANCE

 $(C_T = C_C + C_J)$. C_T is measured at 1.0 MHz using a capacitance bridge (Boonton Electronics Model 75A or equivalent).

2. TR, TUNING RATIO

TR is the ratio of C_T measured at 2.0 Vdc divided by C_T measured at 30 Vdc.

3. Q, FIGURE OF MERIT

Q is calculated by taking the G and C readings of an admittance bridge at the specified frequency and substituting in the following equations:

$$Q\,=\,\frac{2\pi fC}{G}$$

(Boonton Electronics Model 33AS8 or equivalent). Use Lead Length $\approx 1/16$ ".

4. TC_C, DIODE CAPACITANCE TEMPERATURE COEFFICIENT

 TC_C is guaranteed by comparing C_T at $V_R=4.0$ Vdc, f=1.0 MHz, $T_A=-65^{\circ}C$ with C_T at $V_R=4.0$ Vdc, f=1.0 MHz, $T_A=+85^{\circ}C$ in the following equation, which defines TC_C :

$$\mathsf{TC}_{C} = \left| \frac{\mathsf{C}_{T}(+\ 85^{\circ}\mathsf{C}) - \mathsf{C}_{T}(-65^{\circ}\mathsf{C})}{85 + 65} \right| \cdot \frac{10^{6}}{\mathsf{C}_{T}(25^{\circ}\mathsf{C})}$$

Accuracy limited by measurement of C_T to ± 0.1 pF.

TYPICAL DEVICE CHARACTERISTICS

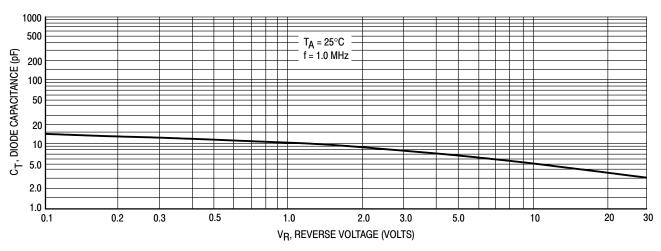


Figure 1. Diode Capacitance versus Reverse Voltage

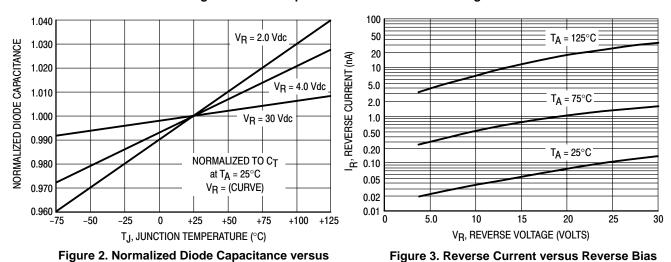


Figure 2. Normalized Diode Capacitance versus Junction Temperature

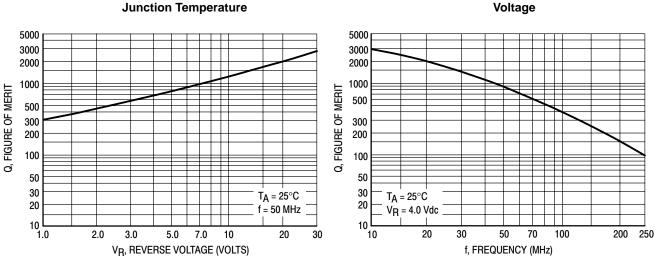
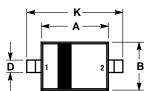


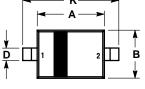
Figure 4. Figure of Merit versus Reverse Voltage

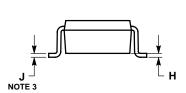
Figure 5. Figure of Merit versus Frequency

PACKAGE DIMENSIONS



SOD-323 PLASTIC PACKAGE CASE 477-02 **ISSUE A**





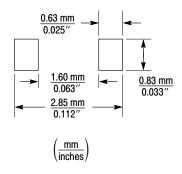


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.60	1.80	0.063	0.071	
В	1.15	1.35	0.045	0.053	
С	0.80	1.00	0.031	0.039	
D	0.25	0.40	0.010	0.016	
Е	0.15 REF		0.006 REF		
Н	0.00	0.10	0.000	0.004	
J	0.089	0.177	0.0035	0.0070	
K	2.30	2.70	0.091	0.106	

STYLE 1: PIN 1. CATHODE 2. ANODE



SOD-323 Soldering Footprint

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